PD-95929

International **IGR** Rectifier **HEXFET® Power MOSFET**

IRFD420PbF

V_{DSS} = 500V

 $R_{DS(on)} = 3.0\Omega$

 $I_{\rm D} = 0.37 {\rm A}$

D

- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- For Automatic Insertion
- End Stackable
- Fast Switching
- · Ease of paralleling
- Simple Drive Requirements
- Lead-Free



Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

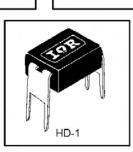
The 4-pin DIP package is a low-cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1 inch pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 watt.

Absolute Maximum Ratings

	Parameter	Max.	Units	
I _D @ T _C = 25°C	Continuous Drain Current, VGS @ 10 V	0.37	1	
I _D @ T _C = 100°C	Continuous Drain Current, V _{GS} @ 10 V	0.23	A	
DM	Pulsed Drain Current O	3.0	_	
P _D @T _C = 25°C	Power Dissipation	1.0	W	
	Linear Derating Factor	0.0083	W/°C	
V _{GS}	Gate-to-Source Voltage	±20	V	
E _{AS}	Single Pulse Avalanche Energy 🛛	51	mJ A	
AR	Avalanche Current 0	0.37		
E _{AR}	Repetitive Avalanche Energy O	0.10	mJ	
dv/dt	Peak Diode Recovery dv/dt 3	3.5	V/ns	
TJ	Operating Junction and	-55 to + 150		
T _{STG}	Storage Temperature Range		°C	
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	1	

Thermal Resistance

	Parameter	Min.	Тур.	Max.	Units °C/W
R _{0JA}	Junction-to-Ambient	-	-	120	



Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V(BR)DSS	Drain-to-Source Breakdown Voltage	500	_	-	V	V _{GS} = 0V, ID = 250µA
ΔV(BR)DSS/ΔTJ	Breakdown Voltage Temp. Coefficient	_	0.59	-	V/⁰C	Reference to 25°C, $I_D = 1mA$
R _{DS(on)}	Static Drain-to-Source On-Resistance	-	-	3.0	Ω	V _{GS} = 10.0V, I _D = 0.22A ④
VGS(th)	Gate Threshold Voltage	2.0	-	4.0	V	V _{DS} = V _{GS} , I _D = 250µA
g fs	Forward Transconductance	1.5	-	-	S	V _{DS} = 50V, I _D = 1.3A
IDSS	Drain-to-Source Leakage Current	-	-	25	μA	V _{DS} = 500V, V _{GS} = 0V
		-	-	250	μΑ	V_{DS} = 400V, V_{GS} = 0V, T_{J} = 125°C
Igss	Gate-to-Source Forward Leakage	-	-	100	- A	V _{GS} = 20V
	Gate-to-Source Reverse Leakage	-	-	-100	nA	V _{GS} = -20V
Qg	Total Gate Charge	-	-	24	nC	I _D = 2.1A
Q _{gs}	Gate-to-Source Charge	-	-	3.3		V _{DS} = 400V
Q _{gd}	Gate-to-Drain ("Miller") Charge		-	13		V _{GS} = 10V @
t _{d(on)}	Turn-On Delay Time	-	8.0	_		V _{DD} = 250V
t _r	Rise Time	-	8.6	-	ns	I _D = 2.1A
t _{d(off)}	Turn-Off Delay Time	-	33	-	115	$R_G = 18\Omega$
t _f	Fall Time	-	16	-		R _D = 120Ω ④
L _D	Internal Drain Inductance	-	4.0	-		Between lead, p
Ls	Internal Source Inductance	-	6.0	-	nH	6mm (0.25in.) from package and center of die contact
Ciss	Input Capacitance	-	360	-		V _{GS} = 0V
Coss	Output Capacitance	-	92	-	pF	V _{DS} = 25V
Crss	Reverse Transfer Capacitance	-	37	-	1	f = 1.0 MHz

Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions	
ls	Continuous Source Current (Body Diode)	-	-	0.37	٨	MOSFET symbol showing the	
I _{SM}	Pulsed Source Current (Body Diode) ①	_	-	5.0	A	p-n junction diode.	
V _{SD}	Diode Forward Voltage	-		1.6	V	$T_{J} = 25^{\circ}C, I_{S} = 0.37A, V_{GS} = 0V$ (9)	
t _{rr}	Reverse Recovery Time	-	260	520	ns	T _J = 25°C, I _F = 2.1A	
Qrr	Reverse RecoveryCharge	- 1	0.70	1.4	μC	di/dt = 100A/µs 🕑	
t _{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by $L_{S}+L_{D}$)					

Notes:

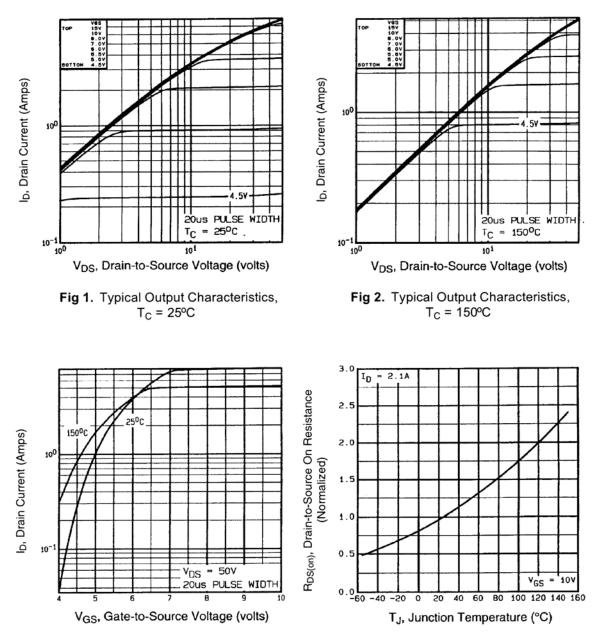
O Repetitive rating; pulse width limited by max. junction temperature.

 () I_{SD} \leq 4.4A, di/dt \leq 90A/µs, V_{DD} \leq V_{(BR)DSS}, T_{\rm J} \leq 150°C

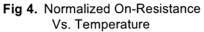
0 V_{DD} = 50V, starting T_J = 25°C, L = 40mH R_G = 25 Ω , I_{AS} = 1.5A.

④ Pulse width \leq 300µs; duty cycle \leq 2%.

International



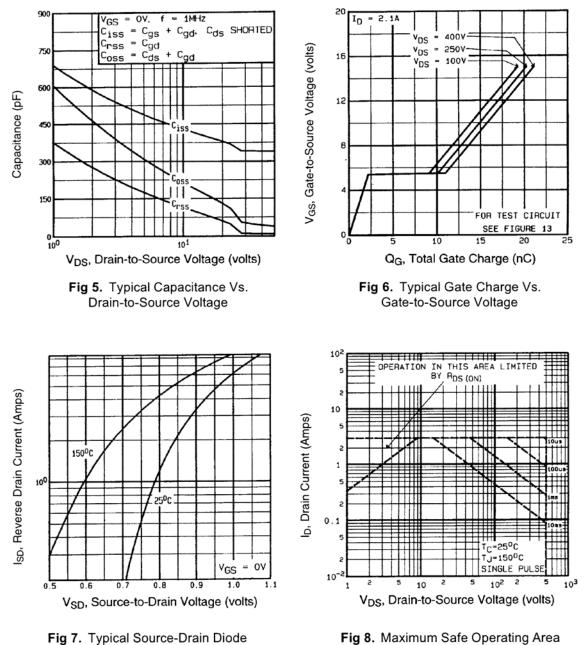




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International

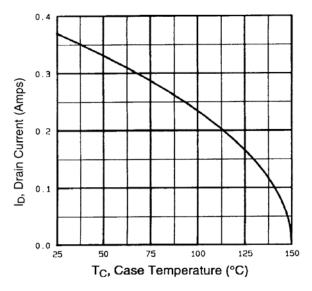


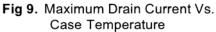
Forward Voltage

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IRFD420PbF





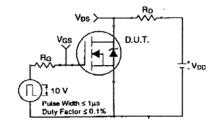


Fig 10a. Switching Time Test Circuit

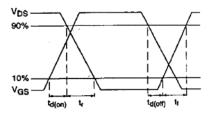


Fig 10b. Switching Time Waveforms

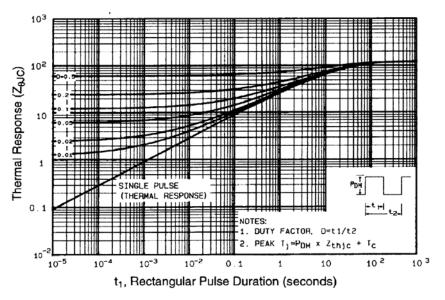


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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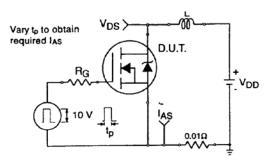


Fig 12a. Unclamped Inductive Test Circuit

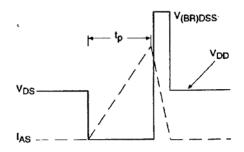


Fig 12b. Unclamped Inductive Waveforms

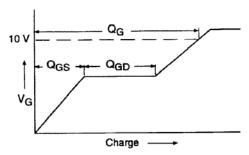


Fig 13a. Basic Gate Charge Waveform

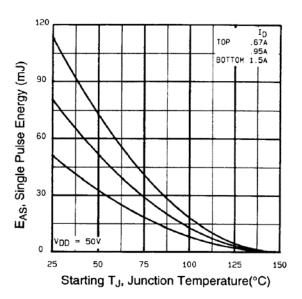


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

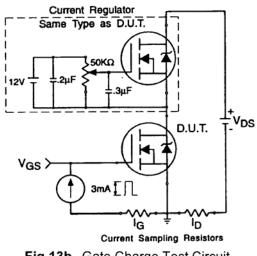


Fig 13b. Gate Charge Test Circuit

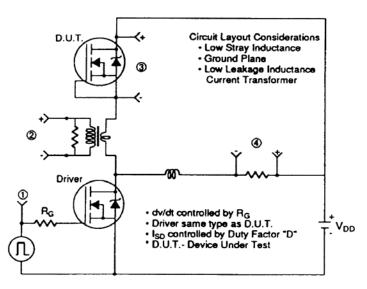
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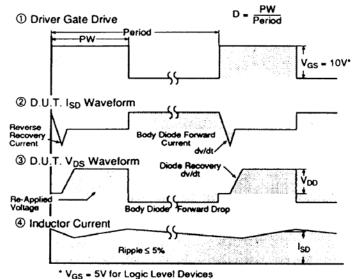
International

dv/dt Test Circuit

Fig 14. For N-Channel HEXFETs



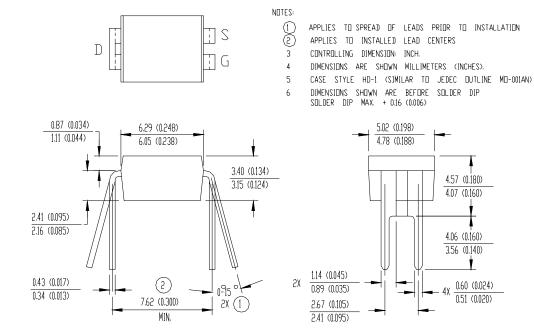
Peak Diode Recovery Test Circuit



IRFD420PbF Hexdip Package Outline

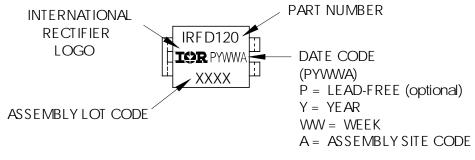
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Dimensions are shown in millimeters (inches)



Hexdip Part Marking Information

EXAMPLE: THIS IS AN IRF D120



Data and specifications subject to change without notice.

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